

PATENT APPLICATION *78*

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant(s): Iver E. Anderson et al.

For

: Pb-Free Sn-Ag-Cu Ternary Eutectic Solder

Serial No.

: 08/094 854

Group

: 3205

Filed

: July 20, 1994Atty. Docket  
No.:Examiner: Knapp  
ISH Case 340The Commissioner of Patents and Trademarks  
Washington, D. C. 20231

CHANGE OF ADDRESS

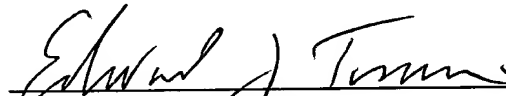
Sir:

The undersigned has a new address and telephone number as  
follows:Mr. Edward J. Timmer  
9733 Sterling Road  
Richland, MI 49083

Phone No. (616) 629-9136

Please send all future correspondence to the new address.

Respectfully submitted,

  
Edward J. Timmer  
Reg. No. 27 402

RECEIVED

AUG 31 1994

GROUP 3200

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Knapp*